

HFA40HF120

Ultrafast, Soft Recovery Diode

Features

- Reduced RFI and EMI
- Reduced Snubbing
- Extensive Characterization of Recovery Parameters
- Hermetic
- Surface Mount

$V_R = 1200V$
$V_F = 3.1V$
$Q_{rr} = 510nC$
$di_{(rec)M}/dt = 350A/\mu s$

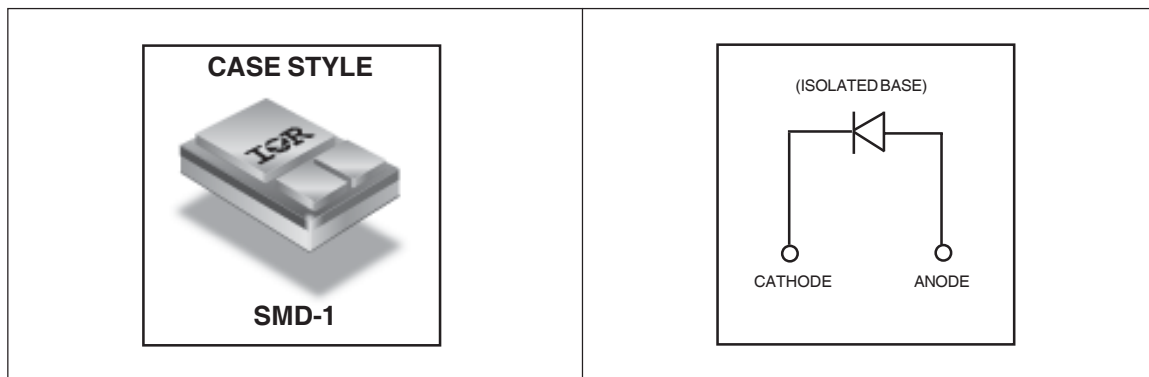
Description

These Ultrafast,soft recovery diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and di/dt simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.

Absolute Maximum Ratings

	Parameter	Max.	Units
V_R	Cathode to Anode Voltage	1200	V
$I_{F(AV)}$	Continuous Forward Current, ① $T_C = 100^\circ C$	11	A
I_{FSM}	Single Pulse Forward Current, ② $T_C = 25^\circ C$	190	
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	83	W
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 to +150	$^\circ C$

Note: ① D.C. = 50% rect. wave
 ② 1/2 sine wave, 60 Hz , PW. = 8.33 ms



Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
V_{BR}	Cathode Anode Breakdown Voltage	1200	—	—	V	$I_R = 100\mu\text{A}$
V_F	Forward Voltage See Fig. 1	—	—	3.2	V	$I_F = 11\text{A}$ $T_J = -55^\circ\text{C}$
		—	—	3.1		$I_F = 11\text{A}$
		—	—	4.0		$I_F = 22\text{A}$
		—	—	2.7		$I_F = 11\text{A}$, $T_J = 125^\circ\text{C}$
I_R	Max Reverse Leakage Current See Fig. 2	—	—	10	μA	$V_R = V_R$ Rated
		—	—	1.0	mA	$V_R = 960\text{V}$, $T_J = 125^\circ\text{C}$
C_T	Junction Capacitance, See Fig. 3	—	28	42	pF	$V_R = 200\text{V}$
L_S	Series Inductance	—	5.9	—	nH	Measured from center of cathode pad the center of anode pad

Dynamic Recovery Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
t_{rr1}	Reverse Recovery Time	—	80	120	ns	$T_J = 25^\circ\text{C}$ See Fig. 5
t_{rr2}		—	130	195		$T_J = 125^\circ\text{C}$
I_{RRM1}	Peak Recovery Current	—	7.25	10.9	A	$T_J = 25^\circ\text{C}$ See Fig. 6
I_{RRM2}		—	10.2	15.3		$T_J = 125^\circ\text{C}$
Q_{rr1}	Reverse Recovery Charge	—	340	510	nC	$T_J = 25^\circ\text{C}$ See Fig. 7
Q_{rr2}		—	825	1240		$T_J = 125^\circ\text{C}$
$di_{(rec)M}/dt1$	Peak Rate of Fall of Recovery Current During t_b	—	230	350	$\text{A}/\mu\text{s}$	$T_J = 25^\circ\text{C}$ See Fig. 8
$di_{(rec)M}/dt2$		—	160	240		$T_J = 125^\circ\text{C}$

Thermal - Mechanical Characteristics

	Parameter	Typ.	Max.	Units
R_{thJC}	Junction-to-Case	—	1.5	$^\circ\text{C}/\text{W}$
Wt	Weight	2.6	—	g

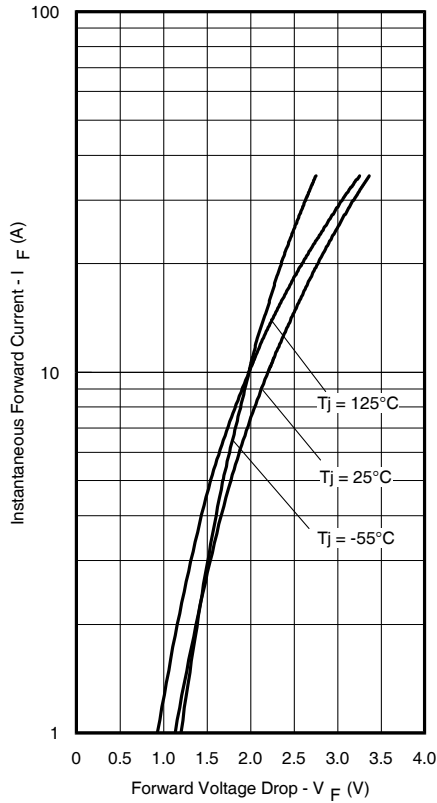


Fig. 1 - Typical Forward Voltage Drop Vs. Instantaneous Forward Current

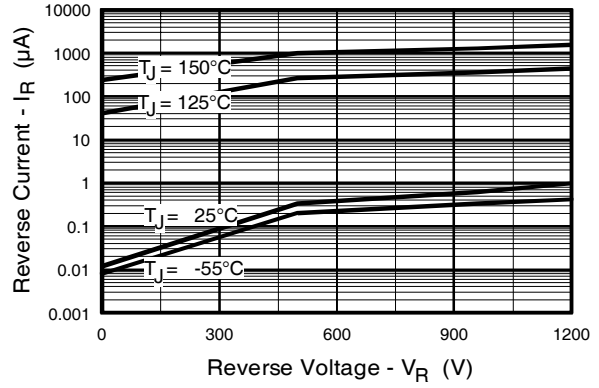


Fig. 2 - Typical Reverse Current Vs. Reverse Voltage

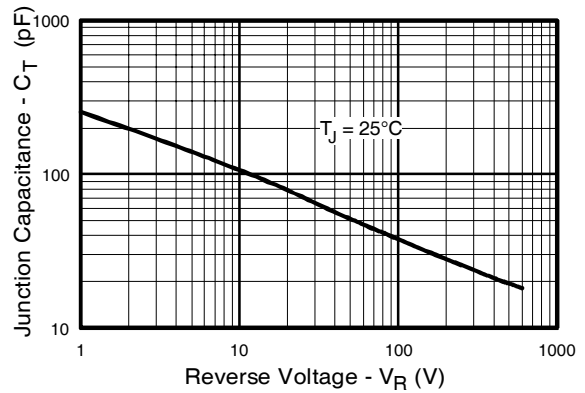


Fig. 3 - Typical Junction Capacitance Vs. Reverse Voltage

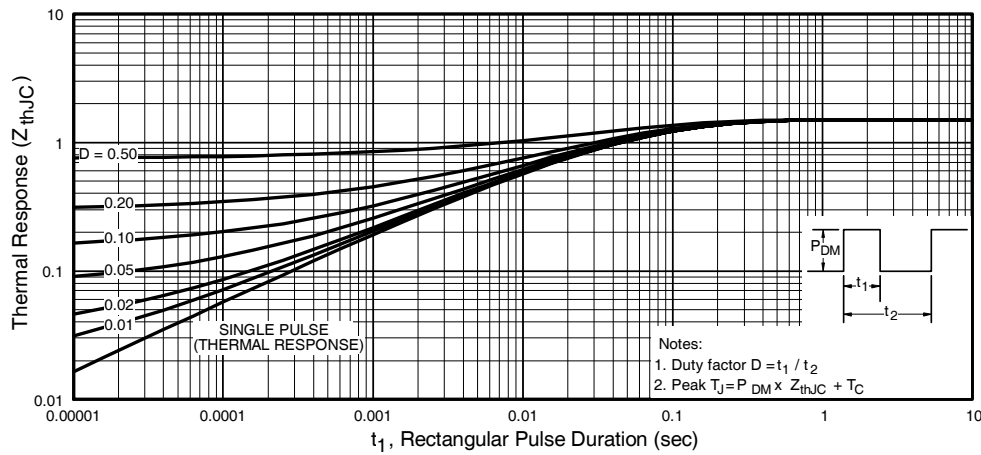


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

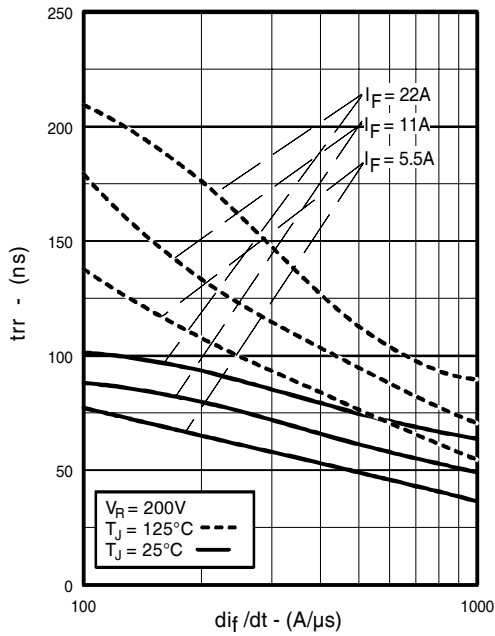


Fig. 5 - Typical Reverse Recovery vs. di_f/dt ,

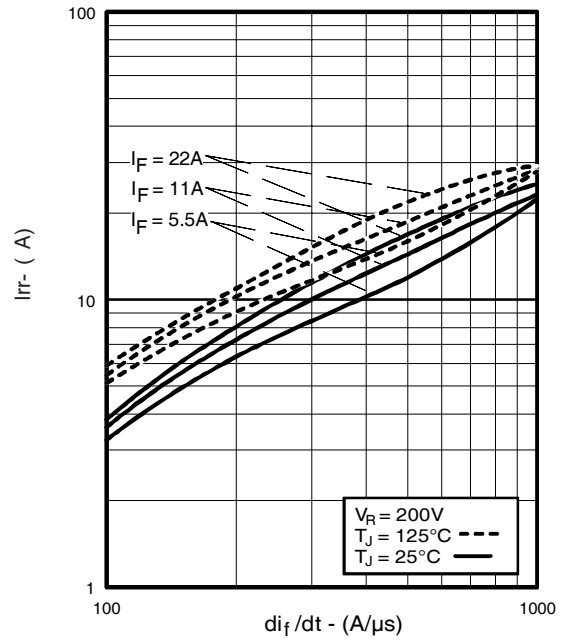


Fig. 6 - Typical Recovery Current vs. di_f/dt ,

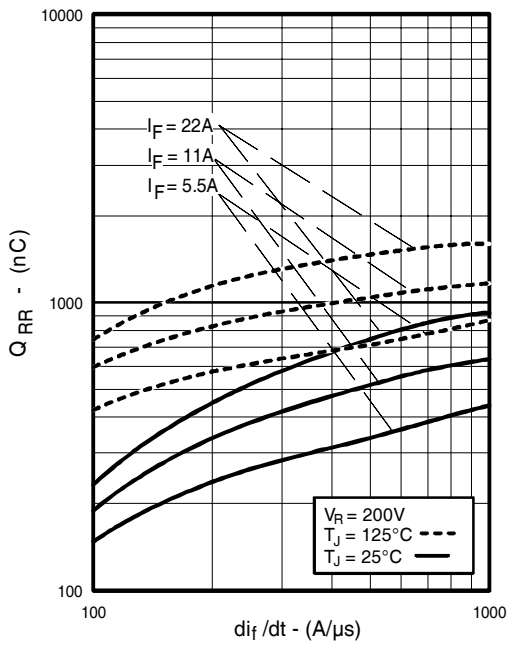


Fig. 7 - Typical Stored Charge vs. di_f/dt

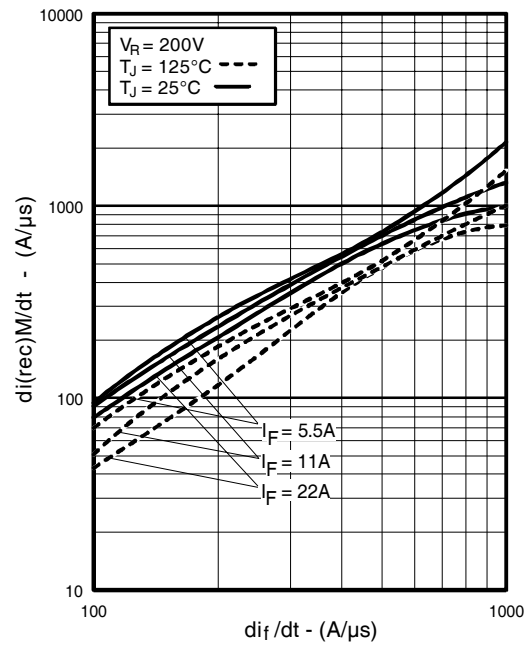
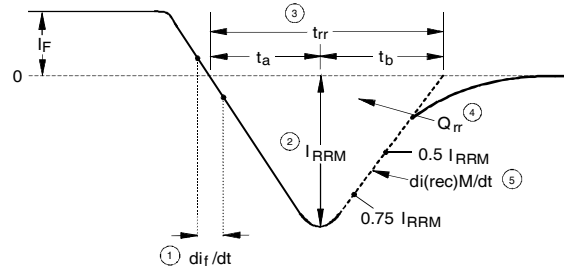
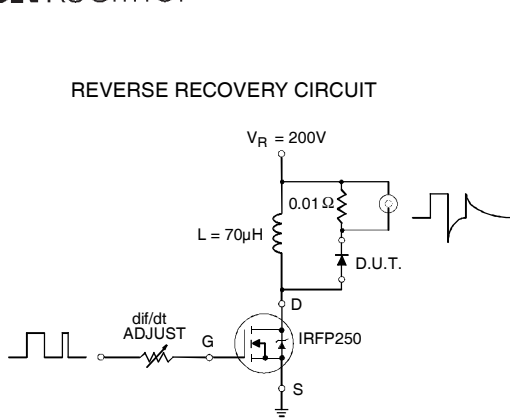


Fig. 8 - Typical $di_{(rec)M}/dt$ vs. di_f/dt



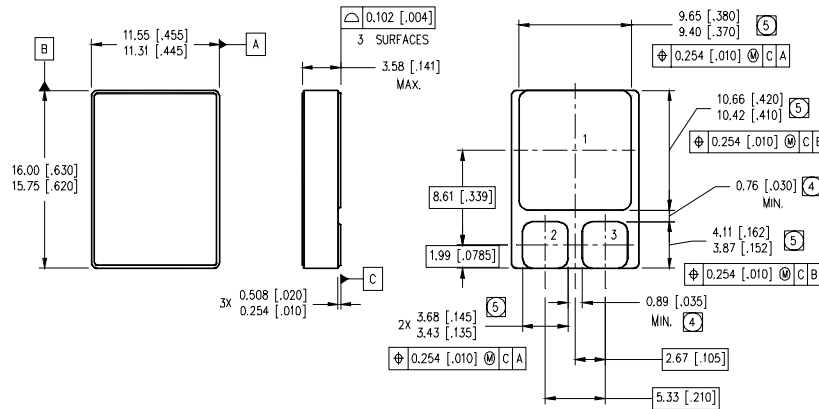
1. di/dt - Rate of change of current through zero crossing
2. I_{RRM} - Peak reverse recovery current
3. t_{rr} - Reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through $0.75 I_{RRM}$ and $0.50 I_{RRM}$ extrapolated to zero current
4. Q_{rr} - Area under curve defined by t_{rr} and I_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$
5. $di(rec)/dt$ - Peak rate of change of current during t_b portion of t_{rr}

Fig. 9 - Reverse Recovery Parameter Test Circuit

Fig. 10 - Reverse Recovery Waveform and Definitions

Case Outline and Dimensions — SMD-1



NOTES:

1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. DIMENSION INCLUDES METALLIZATION FLASH.
5. DIMENSION DOES NOT INCLUDE METALLIZATION FLASH.

PAD ASSIGNMENTS

- 1 = CATHODE
- 2 = ANODE
- 3 = N / C